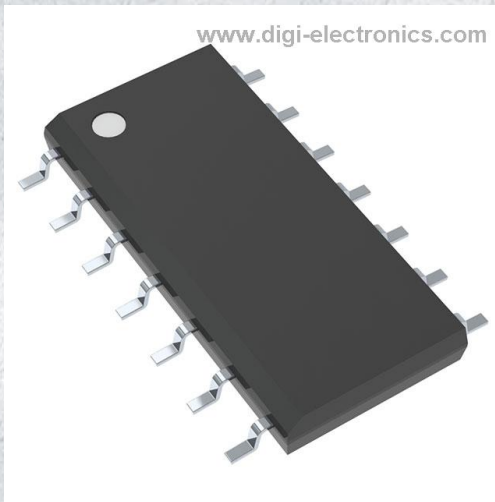


CD4001BCMx Datasheet



<https://www.DiGi-Electronics.com>

DiGi Electronics Part Number	CD4001BCMx-DG
Manufacturer	onsemi
Manufacturer Product Number	CD4001BCMx
Description	IC GATE NOR 4CH 2-INP 14SOIC
Detailed Description	NOR Gate IC 4 Channel 14-SOIC



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.

Purchase and inquiry

Manufacturer Product Number:

CD4001BCMX

Series:

4000B

Logic Type:

NOR Gate

Number of Inputs:

2

Voltage - Supply:

3V ~ 15V

Current - Output High, Low:

3.4mA, 3.4mA

Input Logic Level - High:

3.5V ~ 11V

Operating Temperature:

-55°C ~ 125°C

Supplier Device Package:

14-SOIC

Base Product Number:

CD4001

Manufacturer:

onsemi

Product Status:

Obsolete

Number of Circuits:

4

Features:

-

Current - Quiescent (Max):

1 μ A

Input Logic Level - Low:

1.5V ~ 4V

Max Propagation Delay @ V, Max CL:

70ns @ 15V, 50pF

Mounting Type:

Surface Mount

Package / Case:

14-SOIC (0.154", 3.90mm Width)

Environmental & Export classification

Moisture Sensitivity Level (MSL):

1 (Unlimited)

ECCN:

EAR99

REACH Status:

REACH Unaffected

HTSUS:

8542.39.0001



October 1987
Revised March 2002

CD4001BC/CD4011BC

Quad 2-Input NOR Buffered B Series Gate • Quad 2-Input NAND Buffered B Series Gate

General Description

The CD4001BC and CD4011BC quad gates are monolithic complementary MOS (CMOS) integrated circuits constructed with N- and P-channel enhancement mode transistors. They have equal source and sink current capabilities and conform to standard B series output drive. The devices also have buffered outputs which improve transfer characteristics by providing very high gain.

All inputs are protected against static discharge with diodes to V_{DD} and V_{SS} .

Features

- Low power TTL:
 - Fan out of 2 driving 74L compatibility: or 1 driving 74LS
- 5V–10V–15V parametric ratings
- Symmetrical output characteristics
- Maximum input leakage 1 μ A at 15V over full temperature range

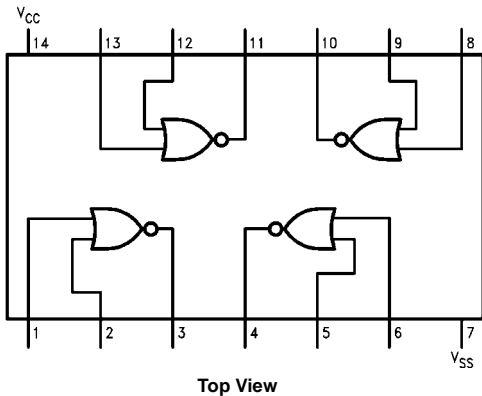
Ordering Code:

Order Number	Package Number	Package Description
CD4001BCM	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
CD4001BCSJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
CD4001BCN	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide
CD4011BCM	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
CD4011BCN	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

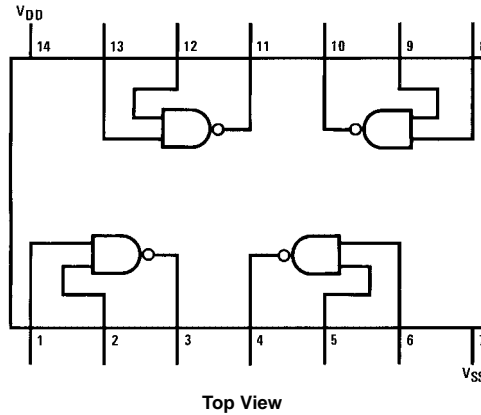
Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagrams

Pin Assignments for DIP, SOIC and SOP
CD4001BC



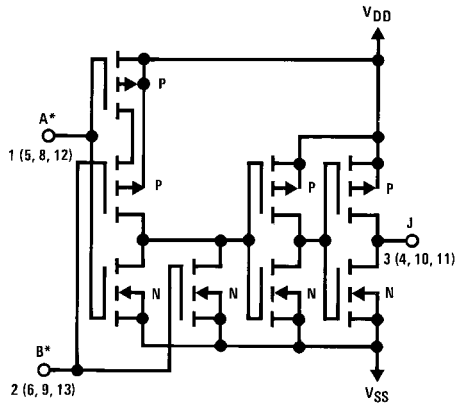
Pin Assignments for DIP and SOIC
CD4011BC



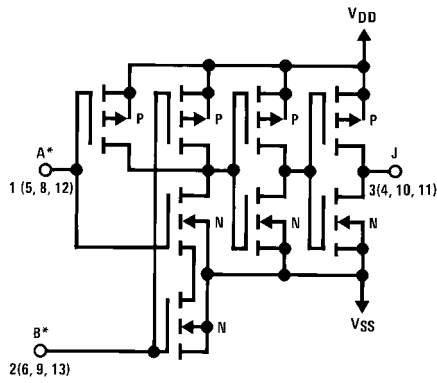
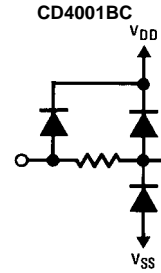
CD4001BC/CD4011BC Quad 2-Input NOR Buffered B Series Gate • Quad 2-Input NAND Buffered B Series Gate

CD4001BC/CD4011BC

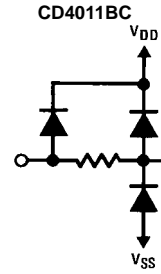
Schematic Diagrams



$1/4$ of device shown
 $J = \overline{A + B}$
 Logical "1" = HIGH
 Logical "0" = LOW
 All inputs protected by standard
 CMOS protection circuit.



$1/4$ of device shown
 $J = \overline{A \cdot B}$
 Logical "1" = HIGH
 Logical "0" = LOW
 All inputs protected by standard
 CMOS protection circuit.



Absolute Maximum Ratings ^(Note 1)			Recommended Operating Conditions								
(Note 2)											
Voltage at any Pin		-0.5V to $V_{DD} + 0.5V$	Operating Range (V_{DD})		$3 V_{DC}$ to $15 V_{DC}$						
Power Dissipation (P_D)			Operating Temperature Range								
Dual-In-Line		700 mW	CD4001BC, CD4011BC		-55°C to +125°C						
Small Outline		500 mW									
V_{DD} Range		-0.5 V_{DC} to +18 V_{DC}	Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The Electrical Characteristics tables provide conditions for actual device operation.								
Storage Temperature (T_S)		-65°C to +150°C	Note 2: All voltages measured with respect to V_{SS} unless otherwise specified.								
Lead Temperature (T_L)		260°C									
(Soldering, 10 seconds)											
DC Electrical Characteristics (Note 2)											
Symbol	Parameter	Conditions	-55°C		+25°C			+125°C		Units	
			Min	Max	Min	Typ	Max	Min	Max		
I_{DD}	Quiescent Device Current	$V_{DD} = 5V, V_{IN} = V_{DD}$ or V_{SS}		0.25		0.004	0.25		7.5	μA	
		$V_{DD} = 10V, V_{IN} = V_{DD}$ or V_{SS}		0.5		0.005	0.50		15		
		$V_{DD} = 15V, V_{IN} = V_{DD}$ or V_{SS}		1.0		0.006	1.0		30		
V_{OL}	LOW Level Output Voltage	$V_{DD} = 5V$		0.05		0	0.05		0.05	V	
		$V_{DD} = 10V$	$ I_O < 1 \mu A$		0.05		0	0.05			0.05
		$V_{DD} = 15V$			0.05		0	0.05			0.05
V_{OH}	HIGH Level Output Voltage	$V_{DD} = 5V$	4.95		4.95	5		4.95		V	
		$V_{DD} = 10V$	9.95		9.95	10		9.95			
		$V_{DD} = 15V$	14.95		14.95	15		14.95			
V_{IL}	LOW Level Input Voltage	$V_{DD} = 5V, V_O = 4.5V$		1.5		2	1.5		1.5	V	
		$V_{DD} = 10V, V_O = 9.0V$		3.0		4	3.0		3.0		
		$V_{DD} = 15V, V_O = 13.5V$		4.0		6	4.0		4.0		
V_{IH}	HIGH Level Input Voltage	$V_{DD} = 5V, V_O = 0.5V$	3.5		3.5	3		3.5		V	
		$V_{DD} = 10V, V_O = 1.0V$	7.0		7.0	6		7.0			
		$V_{DD} = 15V, V_O = 1.5V$	11.0		11.0	9		11.0			
I_{OL}	LOW Level Output Current (Note 3)	$V_{DD} = 5V, V_O = 0.4V$	0.64		0.51	0.88		0.36		mA	
		$V_{DD} = 10V, V_O = 0.5V$	1.6		1.3	2.25		0.9			
		$V_{DD} = 15V, V_O = 1.5V$	4.2		3.4	8.8		2.4			
I_{OH}	HIGH Level Output Current (Note 3)	$V_{DD} = 5V, V_O = 4.6V$	-0.64		-0.51	-0.88		-0.36		mA	
		$V_{DD} = 10V, V_O = 9.5V$	-1.6		-1.3	-2.25		-0.9			
		$V_{DD} = 15V, V_O = 13.5V$	-4.2		-3.4	-8.8		-2.4			
I_{IN}	Input Current	$V_{DD} = 15V, V_{IN} = 0V$		-0.10		-10^{-5}	-0.10		-1.0	μA	
		$V_{DD} = 15V, V_{IN} = 15V$		0.1		10^{-5}	0.10		1.0		
Note 3: I_{OL} and I_{OH} are tested one output at a time.											
AC Electrical Characteristics (Note 4)											
CD4001BC: $T_A = 25^\circ C$, Input $t_r, t_f = 20$ ns. $C_L = 50$ pF, $R_L = 200k$. Typical temperature coefficient is 0.3%/°C.											
Symbol	Parameter	Conditions	Typ	Max	Units						
t_{PHL}	Propagation Delay Time, HIGH-to-LOW Level	$V_{DD} = 5V$	120	250	ns						
		$V_{DD} = 10V$	50	100							
		$V_{DD} = 15V$	35	70							
t_{PLH}	Propagation Delay Time, LOW-to-HIGH Level	$V_{DD} = 5V$	110	250	ns						
		$V_{DD} = 10V$	50	100							
		$V_{DD} = 15V$	35	70							
t_{THL}, t_{TLH}	Transition Time	$V_{DD} = 5V$	90	200	ns						
		$V_{DD} = 10V$	50	100							
		$V_{DD} = 15V$	40	80							
C_{IN}	Average Input Capacitance	Any Input	5	7.5	pF						
C_{PD}	Power Dissipation Capacity	Any Gate	14		pF						
Note 4: AC Parameters are guaranteed by DC correlated testing.											

CD4001BC/CD4011BC

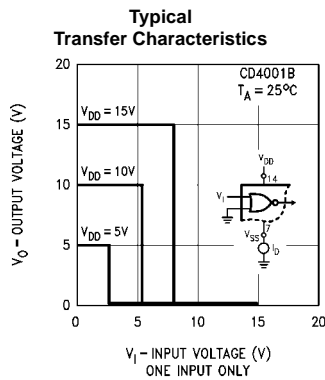
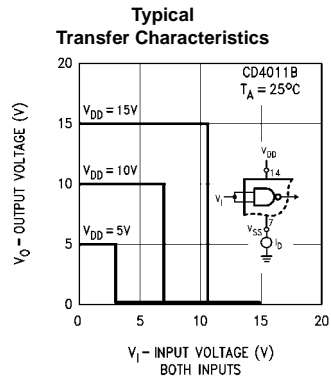
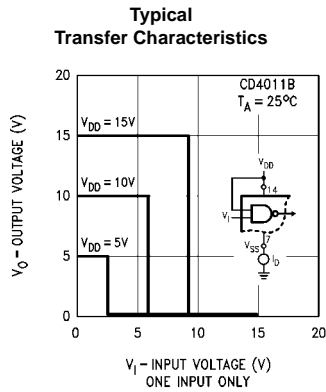
AC Electrical Characteristics (Note 5)

CD4011BC: $T_A = 25^\circ\text{C}$, Input t_r ; $t_f = 20 \text{ ns}$. $C_L = 50 \text{ pF}$, $R_L = 200\text{k}$. Typical Temperature Coefficient is $0.3\%/^\circ\text{C}$.

Symbol	Parameter	Conditions	Typ	Max	Units
t_{PHL}	Propagation Delay, HIGH-to-LOW Level	$V_{DD} = 5\text{V}$	120	250	ns
		$V_{DD} = 10\text{V}$	50	100	
		$V_{DD} = 15\text{V}$	35	70	
t_{PLH}	Propagation Delay, LOW-to-HIGH Level	$V_{DD} = 5\text{V}$	85	250	ns
		$V_{DD} = 10\text{V}$	40	100	
		$V_{DD} = 15\text{V}$	30	70	
t_{THL}, t_{TLH}	Transition Time	$V_{DD} = 5\text{V}$	90	200	ns
		$V_{DD} = 10\text{V}$	50	100	
		$V_{DD} = 15\text{V}$	40	80	
C_{IN}	Average Input Capacitance	Any Input	5	7.5	pF
C_{PD}	Power Dissipation Capacity	Any Gate	14		pF

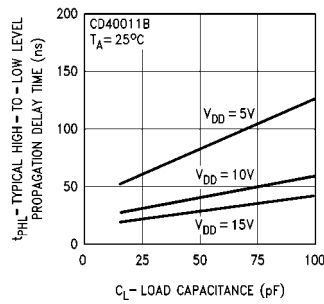
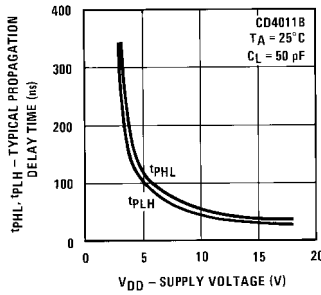
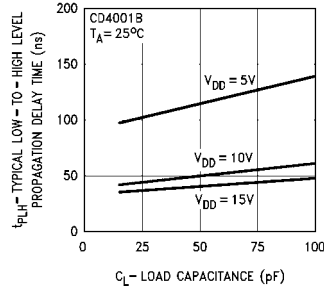
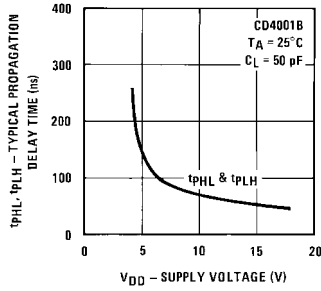
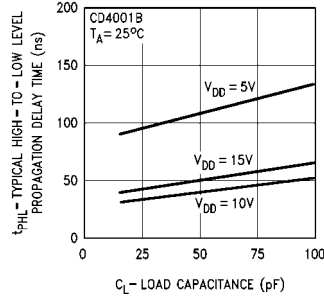
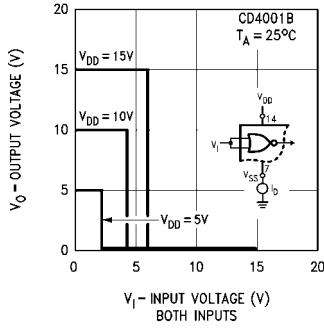
Note 5: AC Parameters are guaranteed by DC correlated testing.

Typical Performance Characteristics



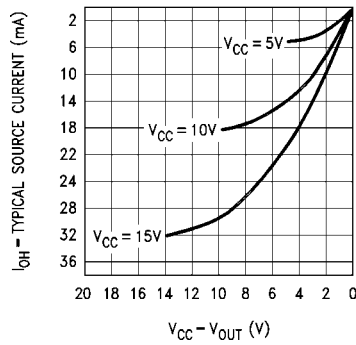
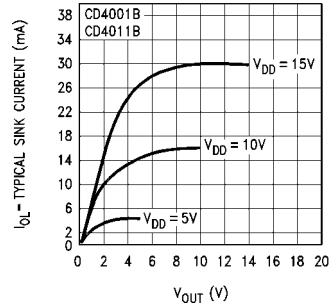
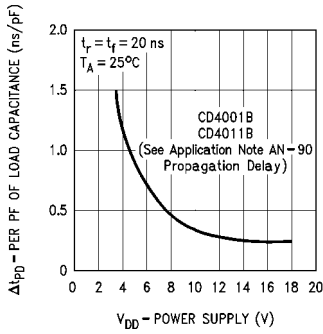
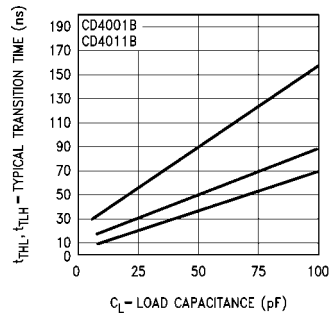
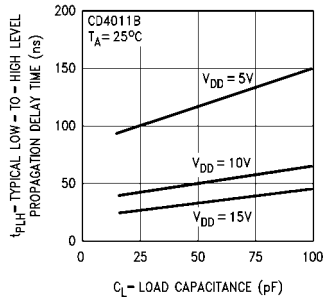
Typical Performance Characteristics (Continued)

Typical Transfer Characteristics

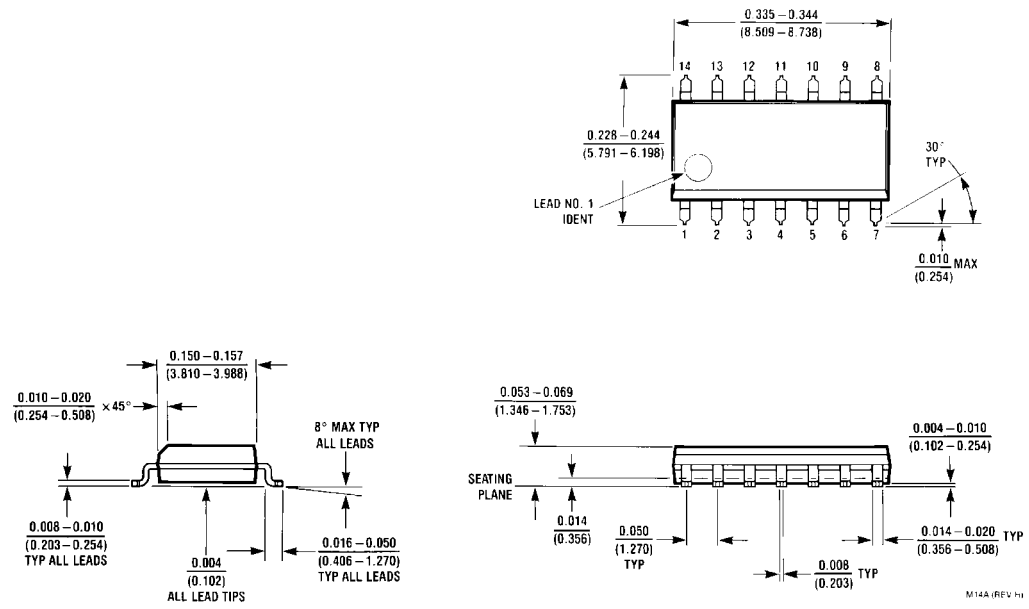


CD4001BC/CD4011BC

Typical Performance Characteristics (Continued)



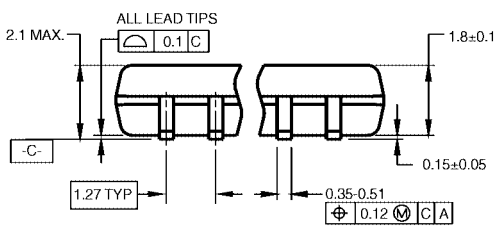
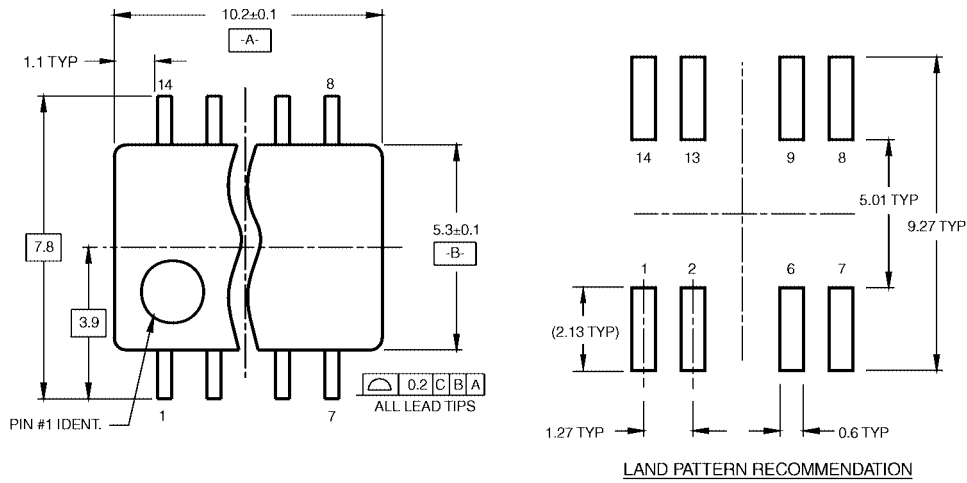
Physical Dimensions inches (millimeters) unless otherwise noted



**14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
Package Number M14A**

CD4001BC/CD4011BC

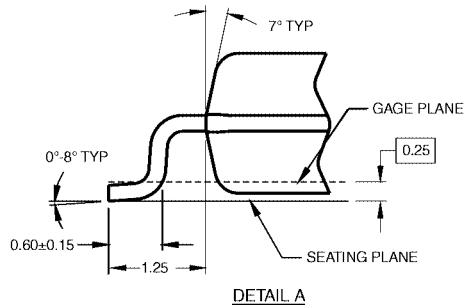
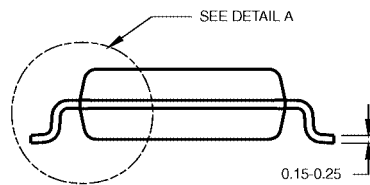
Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



DIMENSIONS ARE IN MILLIMETERS

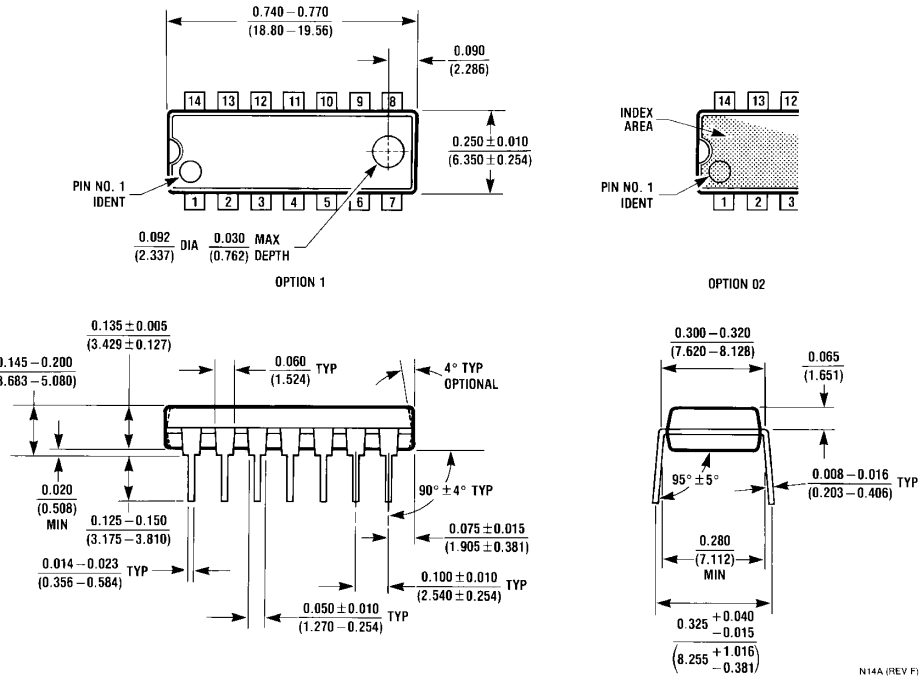
- NOTES:
 A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
 B. DIMENSIONS ARE IN MILLIMETERS.
 C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

M14DRevB1



**14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
 Package Number M14D**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N14A

N14A (REV F)

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